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(12) **United States Design Patent**  
**Tosto et al.**

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(54) **MODULAR PROBE**  
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(\*\*) Term: **14 Years**

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(21) Appl. No.: **29/484,162**  
(22) Filed: **Mar. 6, 2014**  
(51) **LOC (10) Cl.** ..... **13-03**  
(52) **U.S. Cl.**  
USPC ..... **D13/147; D13/199**  
(58) **Field of Classification Search**  
USPC ..... D13/101, 110, 118, 123, 133, 146, 147,  
D13/154, 184, 199; 307/150, 152; 361/600,  
361/601, 622, 730, 796, 809; 439/62, 79,  
439/260, 329, 395, 422, 499  
CPC ..... H01R 12/79; H01R 12/88  
See application file for complete search history.

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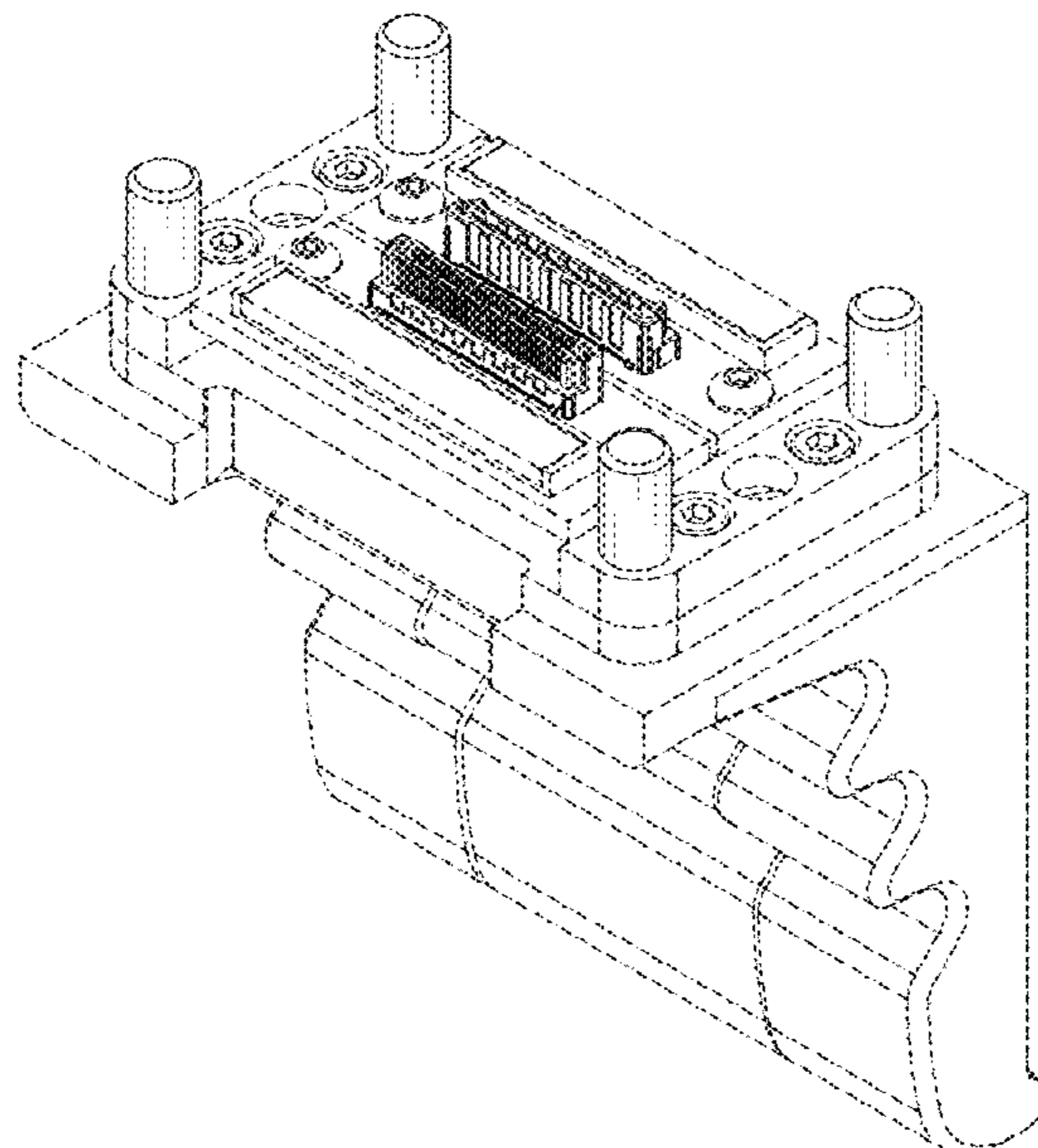
(57) **CLAIM**  
The ornamental design for a modular probe, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view thereof;  
FIG. 2 is a front elevation thereof;  
FIG. 3 is a right elevation thereof;  
FIG. 4 is a top plan view thereof;  
FIG. 5 is a back elevation thereof; and,  
FIG. 6 is a left elevation thereof.  
The broken lines shown represent unclaimed subject matter and form no part of the claimed design.

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**1 Claim, 6 Drawing Sheets**



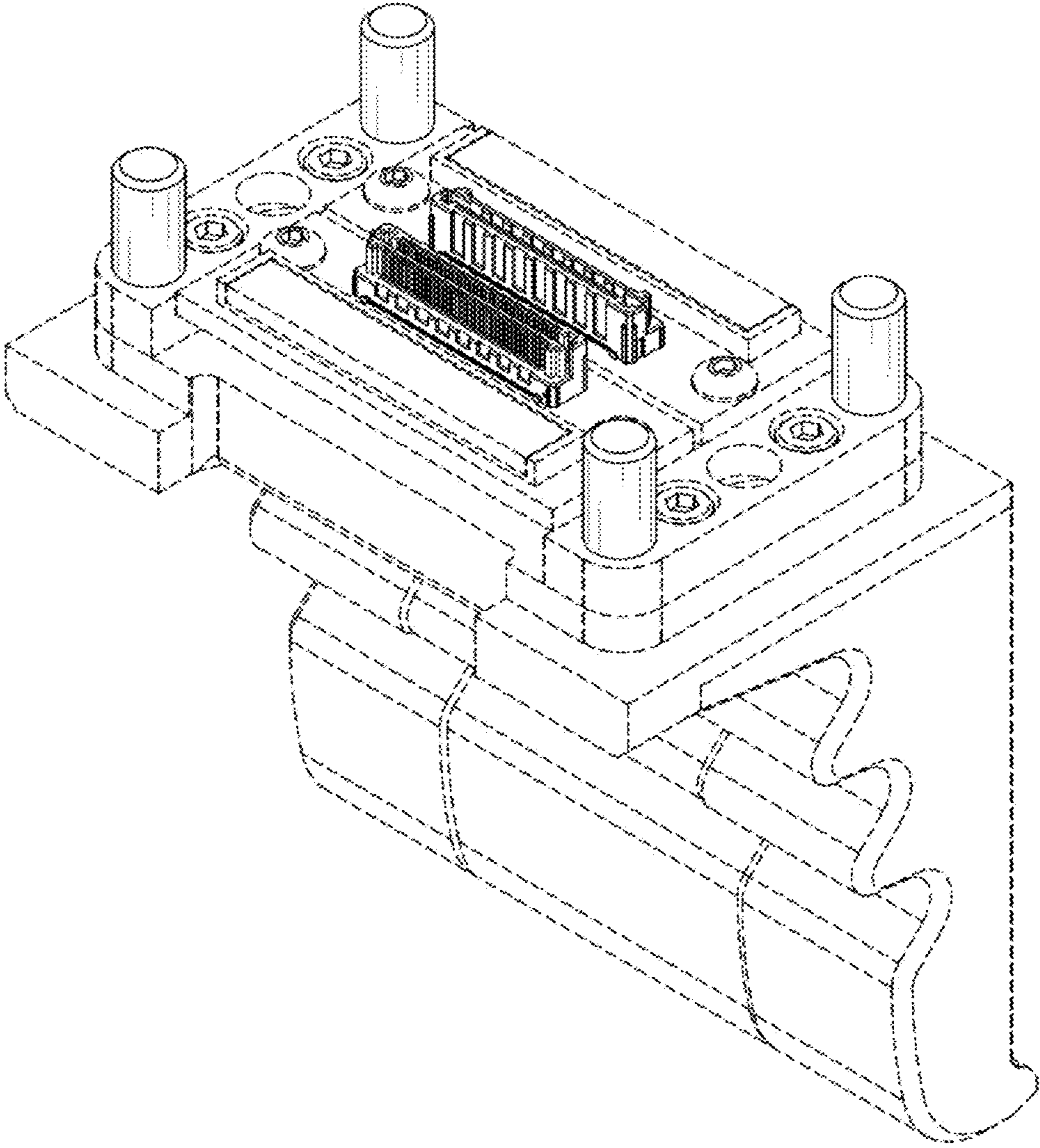


FIG. 1

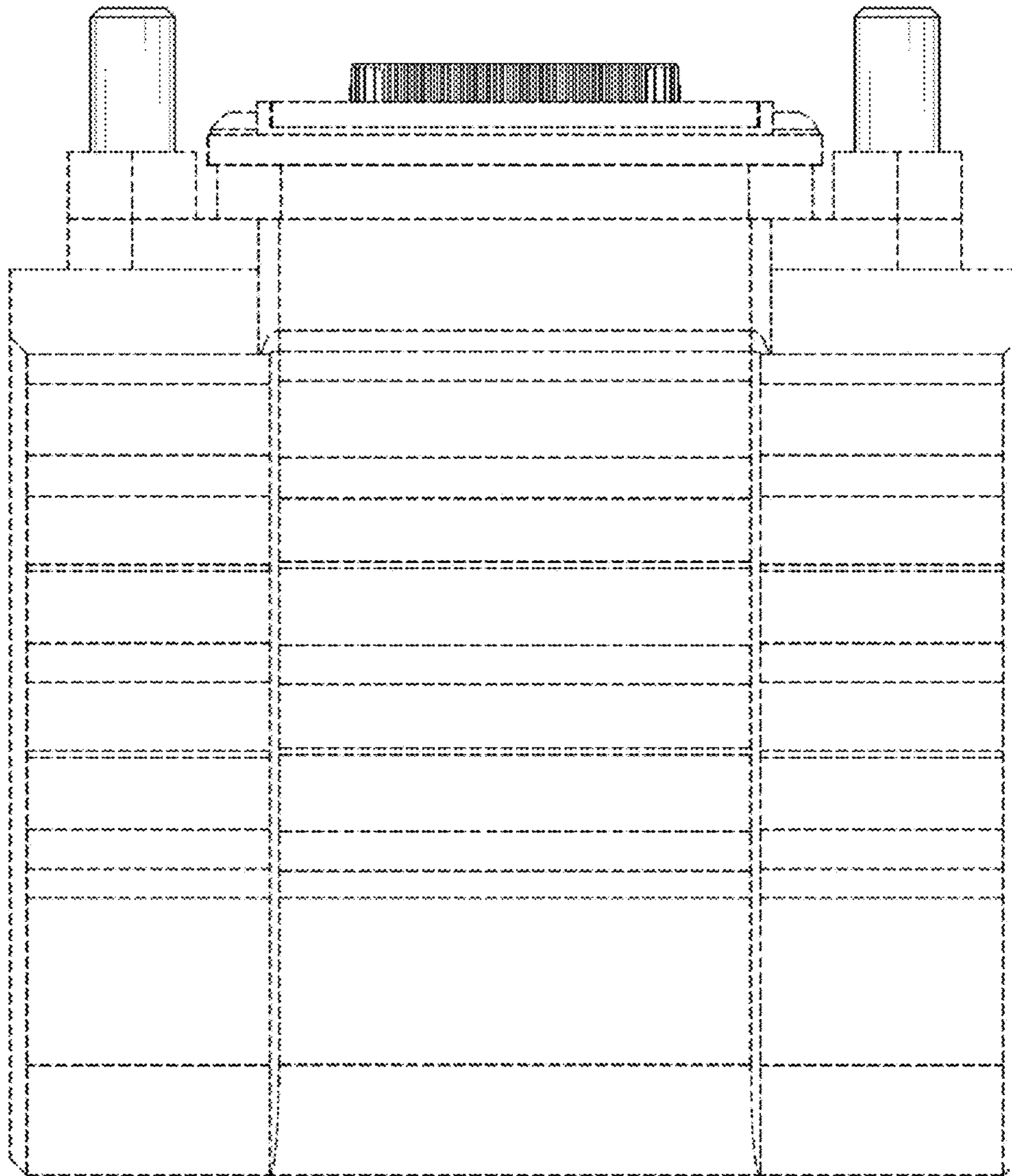


FIG. 2

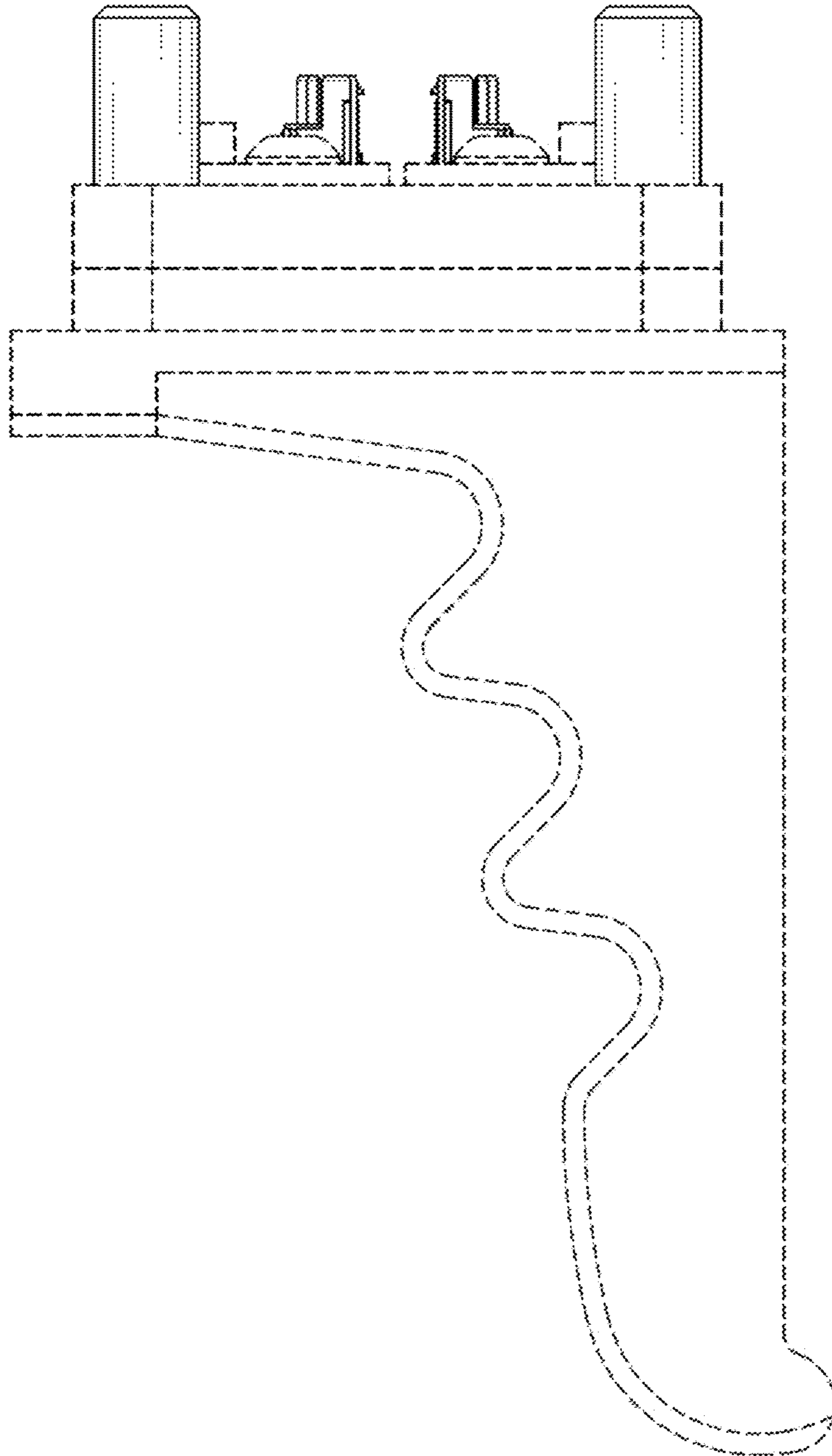


FIG. 3

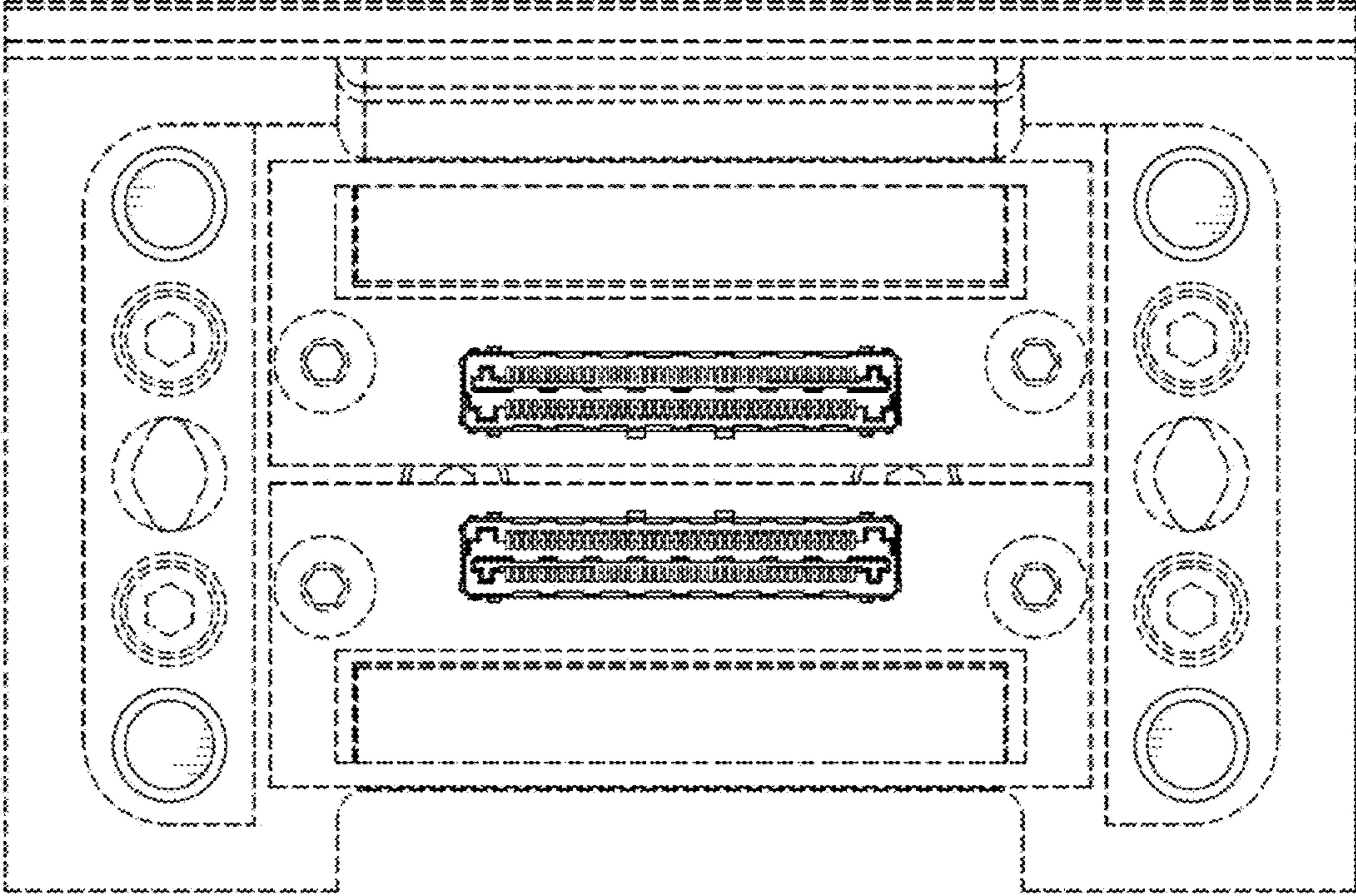


FIG.4

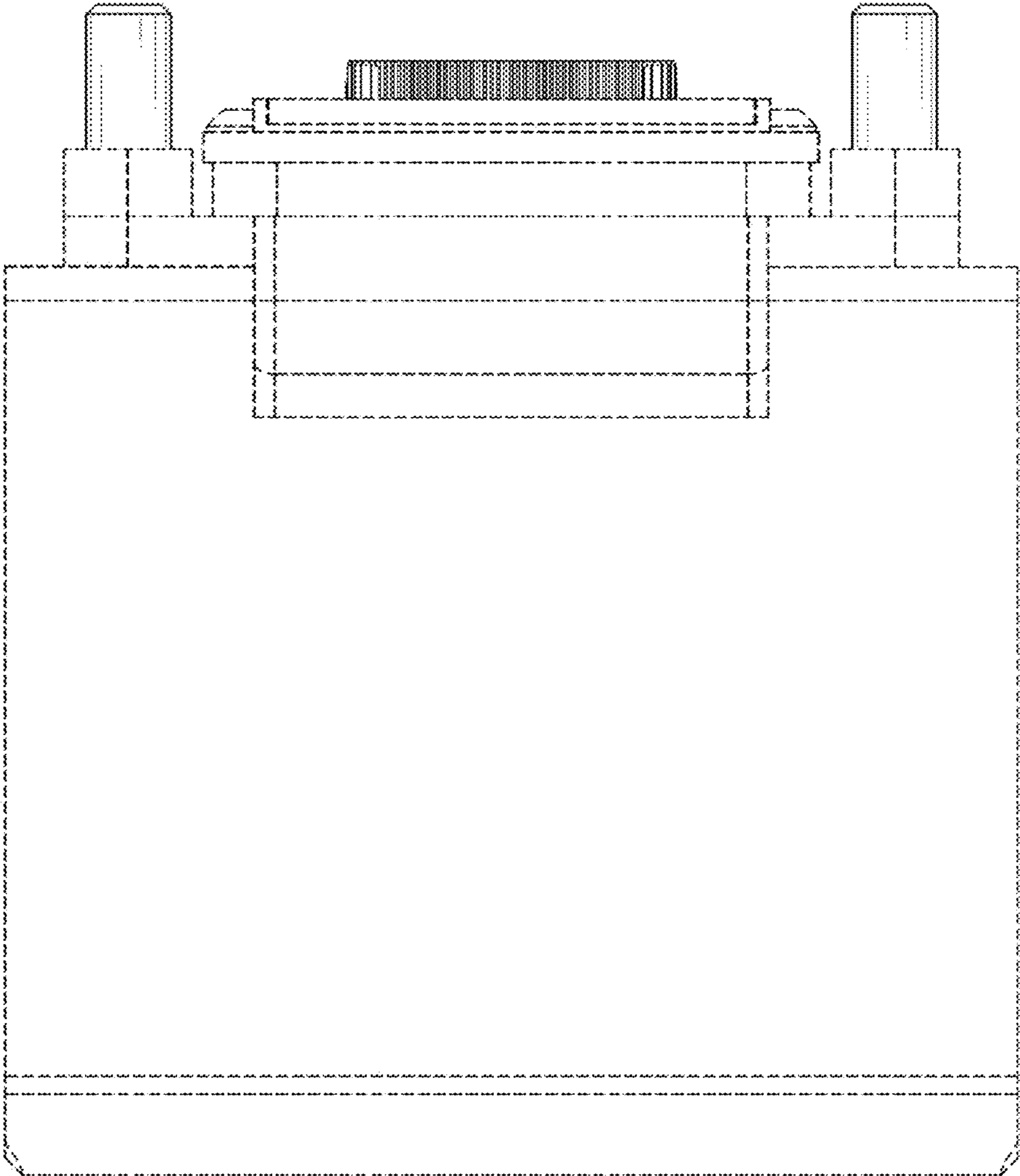


FIG. 5

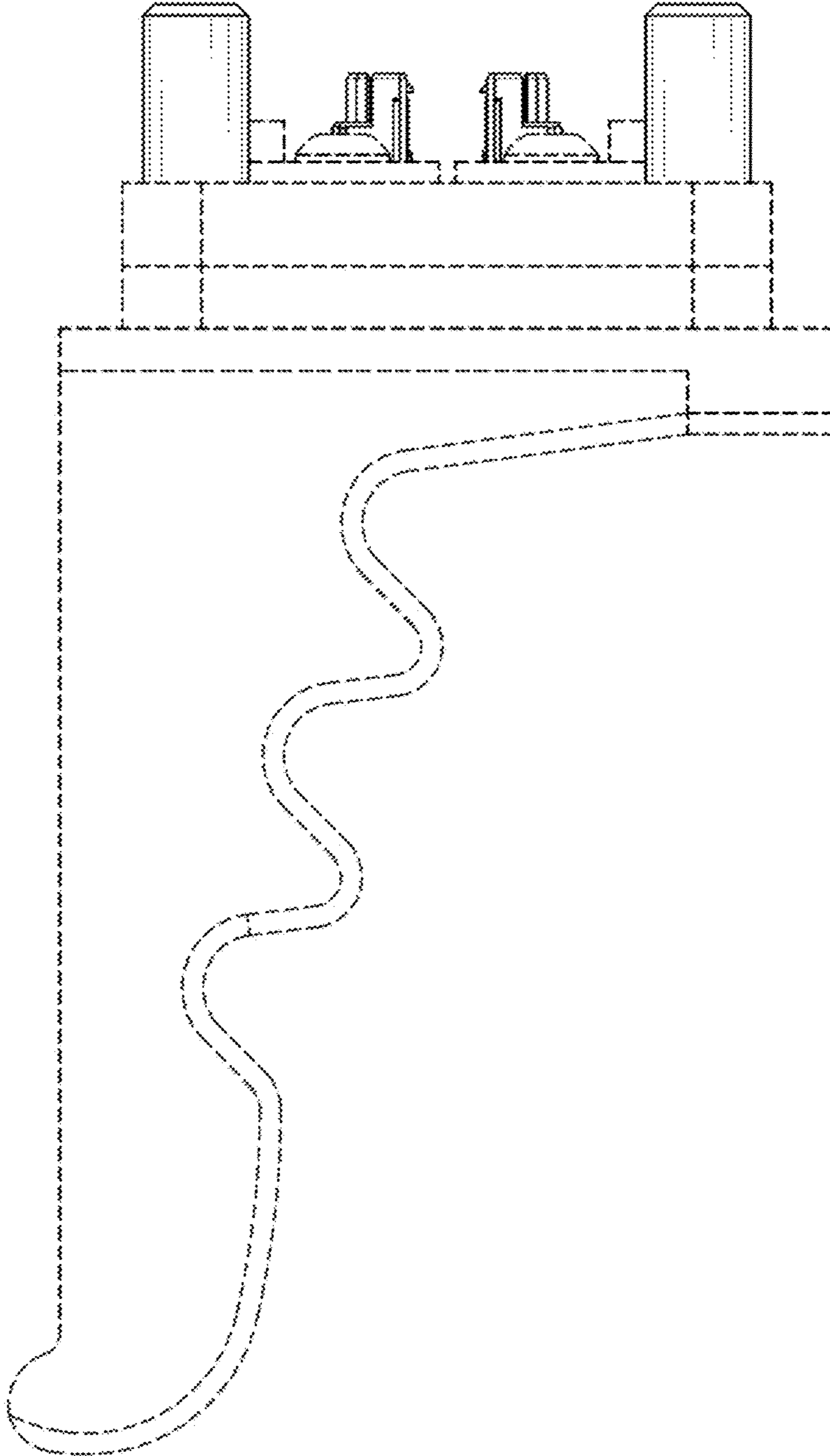


FIG. 6